

1. Description, Features and Applications

This product is suitable for the overcurrent protection of the primary and secondary circuit boards of various electronic equipment circuits, and is widely used in solid-state lighting, battery charging, LED AC/DC power supplies, network communications, medical instruments and Industrial controllers etc.

STE/STS series slow-blow square Surface Mount fuses are ceramic tube/end cap constructions, RoHS compliant, Halogen Free and lead(Pb) exempts of the requirements of RoHS Directive(2002/95/EC), with U.S. (UL/CSA) safety agency approvals. Provide board level primary and secondary circuit protection in a wide variety of applications. With excellent inrush current withstanding capability, excellent reliability for thermal and mechanic shock, also have a high reliability and stable solder ability, end caps are available in gold/silver/nickel plated.

Features:

- Time-Lag (Slow-Blow)
- Wide range of current rating available
- Low temperature de-rating
- Tape and Reel for automatic placement
- Small size(6.1mm*2.5mm)
- · Wide operating temperature range
- RoHS compliant
- Conflict free metals

Applications:

- · LED lighting
- LCD backlight inverter
- PC server
- Wireless base station
- Digital camera

- · Notebook PC
- Portable Devices
- · Cooling fan system
- White goods
- · Industrial equipment
- Battery devices
- Power supply
- Storage system
- Game console
- · Medical equipment
- · LCD/PDP devices
- · Networking devices
- · Telecom system
- Office equipment
- · Automotive devices



2 Catalogue No., ullet Approved / \bigcirc Pending

Ontology		Velterre	D Isian	Nominal Cold	12-14-14-1	Agency Ap	provals
Catalog No.	Ampere Rating	Voltage Rating	Breaking Capacity	Resistance (Ohms)	l ² TMelting Integral(A ² .S)		
STE0160	160mA			2.300	0.058	•	•
STE0200	200mA			1.650	0.062	•	•
STE0250	250mA			1.450	0.065	•	•
STE0300	300mA			0.850	0.191	•	•
STE0315	315mA			0.650	0.202	•	•
STE0375	375mA			0.610	0.330	•	•
STE0400	400mA			0.580	0.338	•	•
STE0500	500mA			0.320	0.475	•	•
STE0600	600mA			0.265	0.775	•	•
STE0630	630mA			0.256	0.986	•	•
STE0700	700mA			0.230	2.105	•	•
STE0750	750mA			0.225	2.240	•	•
STE0800	800mA			0.203	2.380	•	•
STE1100	1A			0.128	3.690	•	•
STE1125	1.25A		50A@300VAC	0.092	3.760	•	•
STE1150	1.5A	125VAC/DC	50A@250VAC	0.085	6.765	•	•
STE1160	1.6A		200A@125VAC	0.075	6.805	•	•
STE1200	2A			0.038	12.150	•	•
STE1250	2.5A			0.035	16.025	•	•
STE1300	3A			0.026	21.560	•	•
STE1315	3.15A			0.025	25.750	•	•
STE1350	3.5A			0.023	30.050	•	•
STE1400	4A			0.019	43.208	•	•
STE1500	5A			0.013	55.250	•	•
STE1600	6A			0.011	75.245	•	•
STE1630	6.3A			0.010	93.550	•	•
STE1700	7A			0.009	97.120	•	•
STE1800	8A			0.0078	108.750	•	•
STE2100	10A			0.0066	118.380	•	•
STE2120	12A			0.0045	140.080	•	•
STE2150	15A			0.0030	210.680	•	•
STS2160	16A	72VDC	500A@72VDC	0.0028	215.250	•	•
STS2200	20A	72VDC	500A@72VDC	0.0020	358.080	•	•
STS2250	25A	72VDC	500A@72VDC	0.00158	465.170	•	•
STS2300	30A	72VDC	500A@72VDC	0.00145	989.650	•	•
STS2400	40A	63VDC	500A@63VDC	0.00120	1050.780	•	•



- *: These catalog no. cold resistance and I2t value are pending due to fuse elements shall be customized;
- ▶ DC Cold Resistance are measured at <10% of rated current in ambient temperature of 25°C;</p>
- Typical Pre-arching I2t are calculated at 10*In Current or 8ms;
- Min Interrupting Rating: 1.35*In.

3. Product Marking

The fuses shall have the following markings, Example:

1A

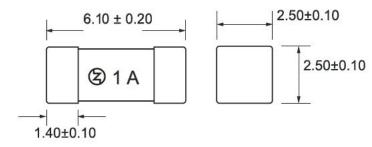
Rated Current (A):

A or mA

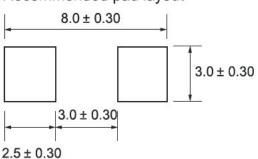
Note: Size and position of the markings shall not be provided.

4. Dimensions and Structure

Unit: mm



Recommended pad layout



5. Material Details

NO.	Part Name	Material
1	End caps	Au Plated Brass Cap
2	Body	Non-Transparent Square Ceramic Tube
3	Fuse element	Cu-Ag Alloy wire

6. Product Characteristics



NO.	Item	Content	Reference standards
1	Product Marking	Brand, Ampere Rating	
2	Operating Temperature	-55°C to 125°C	IEC60068-2-1/2
3	Solderability	T=240°C±5°C, t=3sec±0.5sec, Coverage≥95%	MIL-STD-202, Method 208
4	Resistance to Soldering Heat	10 sec at 260°C	MIL-STD-202, Method 210, Test condition B
5	Insulation Resistance (after Opening)	10,000 ohms minimum	MIL-STD-202, Method 302, Test Condition A
6	Thermal Shock	5 cycles, -65°C / +125°C, 15 minutes at each extreme	MIL-STD-202, Method 107, Test Condition B
7	Mechanical Shock	100G's peak for 6 milliseconds, 3cycles	MIL-STD-202, Method 213, Test
8	Vibration	0.03"amplitude, 10-55 Hz in 1 min. 2hrs each XYZ=6hrs	MIL-STD-202, Method 201
9	Moisture Resistance	10 cycles	MIL-STD-202, Method 106
10	Salt Spray	5% salt solution, 48hrs	MIL-STD-202, Method 101, Test Condition B

7. Electrical Characteristics

7.1 Test Condition

All electrical test is to be conducted with the ambient air at a temperature of 25±5°C.

7.2 Interrupting Rating:

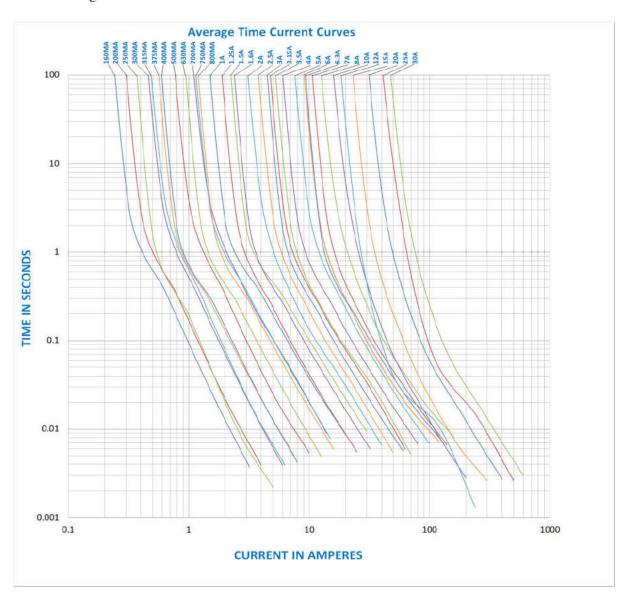
Breaking Capacity: 50A@250Vac, 200A@125Vac.



7.3 Operating Characteristics

% of Ampere Rating(In)	Blowing Time
100% * In	(4 hours Min)
200% * In	(120 sec Max)

7.4 Average Time Current Curves



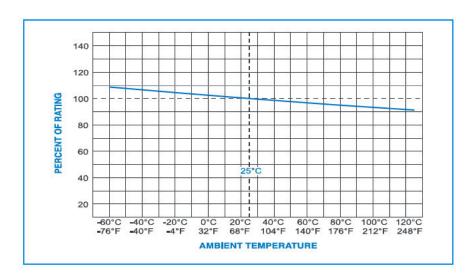
8. Environmental Characteristic

When choosing the fuse's specification, if the operating environmental temperature beyond the scope from $20\sim30^{\circ}$ C, engineer should consider the environmental temperature's affection to fuses.

Specifications are subject to change without notice



Please refer: Temperature Rerating Curve:



9. Recommended Soldering Parameters

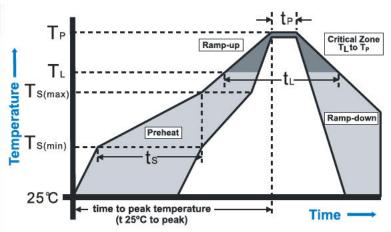
A. Wave /Reflow Soldering Parameters:

Solder paste process.

Solder Pot Temperature: 260°C Max;

Solder Dwell Time: 5 seconds max

Reflow Condition		Pb-Free assembly	
Average ramp-up rate (Ts(max)to Tp)		5°C /second max.	
Preheat	Temperature Min (Ts(min))	150°C	
	Temperature Max (Ts(max))	200°C	
	Time (Min to Max) (ts)	60-120 seconds	
Reflow	Temperature (T _L)	220°C	
	Time Max (t _L)	60 seconds	
Peak Temperature(Tp)		260°C max	
Ramp-down Rate		5°C/second max	
Time 25°C to peak Temperature (Tp)		8 minutes max	



B. Hand-Solder Parameters:

Solder Iron Temperature: 300±5℃

Heating Time: 1~2 s Max

Specifications are subject to change without notice